LPM 2026 Session Chart (Tentative as of April 21)

	Monday	DAY-1: JUNE 9 (Tue)				DAY-2: JUNE 10 (Wed)				DAY-3: JUNE 11 (Thurs)				DAY-4: JUNE 12 (Fri)
		Room 1	Room 2	Room 3	Committee Room	Room 1	Room 2	Room 3	Committee Room	Room 1	Room 2	Room 3	Committee Room	Plenary room
7:40														
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8:00														
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8:20														
8:30		Welcome Opening Remark				Glass, ceramic, and other transparent materials processing, I	3D printing and additive manufacturing, I	Modeling, simulation, and AI approaches for laser-material interactions		Micro/nano-machining and fabrication, I	Surface modification	Surface micro/nano structuring, I		Closing Plenary 1: Norman Hodgson, Industrial UV Lasers – State-of-the-Art, Applications, Market, and Outlook
8:40														
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9:20		Plenary talk 1: Dustin Froula, A future of inertial confinement fusion without laser-plasma instabilities												
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10:10		Plenary talk 2, Michael Schmidt, Beam shaping and production technology – a bidirectional relationship												Closing Plenary 2: Yung Shin, Interaction of ultrafast lasers with complex material systems with the effects of plasma
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10:30						COFFEE BREAK				COFFEE BREAK				
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11:00														
11:10		Plenary talk 3: Jiwang Yan, From Machining Waste to Functional Materials: Laser-Based Approaches toward Closed-Loop Manufacturing				Glass, ceramic, and other transparent materials processing, II	3D printing and additive manufacturing, II	Sensing and diagnostics		Micro/nano-machining and fabrication, II	Fundamentals of laser-materials interaction	Surface micro/nano structuring, II		Closing Plenary 3: Roberto Osellame, Femtosecond laser micromachining of transparent materials for advanced devices
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12:10														Awards and Closing
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12:30														
12:40		LUNCH BREAK				Lunch Break			Women in Photonics and Laser Manufacturing Luncheon Session	Lunch Break				
12:50														
13:00														
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13:30		Microprocessing of Silicon and Silicon Carbid, I	Laser drilling, cutting, and forming, I	Laser processing for battery, fuel-cell, electrolyzer, fusion energy, and other energy devices		Laser-based direct writing, I	3D printing and additive manufacturing, III	Micro-welding and micro-bonding,I		Micro/nano-machining and fabrication, III	Novel Systems and Processes	Surface micro/nano structuring, III		
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15:00						COFFEE BREAK				COFFEE BREAK				
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15:20		COFFEE BREAK												
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15:40		Microprocessing of Silicon and Silicon Carbid, II	Laser drilling, cutting, and forming, II			Laser-based direct writing, II	Laser synthesis and processing of functional nanomaterials and 3D printing	Micro-welding and micro-bonding,II		Micro/nano-machining and fabrication, IV	Beam shaping			
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17:20										Poster / Exhibition / Networking Event				
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19:20						Banquet								
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20:10	Welcom Reception at Hyatt													
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